

Click here for the 3D model.

| Dimensions |  |
| :--- | :--- |
| Chip Size | 0603 |
| L | $1.6 \mathrm{~mm}+/-0.17 \mathrm{~mm}$ |
| W | $0.8 \mathrm{~mm}+/-0.15 \mathrm{~mm}$ |
| T | $0.8 \mathrm{~mm}+/-0.07 \mathrm{~mm}$ |
| S | 0.58 mm MIN |
| B | $0.45 \mathrm{~mm}+/-0.15 \mathrm{~mm}$ |


| Packaging Specifications |  |
| :--- | :--- |
| Packaging | T\&R, 180mm, Paper Tape |
| Packaging Quantity | 4000 |


| General Information |  |
| :--- | :--- |
| Series | SMD Auto U2J Flex |
| Style | SMD Chip <br> Automotive Grade |
| Description | FT-CAP, Ultra-Stable, Automotive Grade |
| Features | Yes |
| RoHS | Flexible Termination |
| Termination | No |
| Marking | AEC-Q200 |
| Qualifications | Yes |
| AEC-Q200 | 3.7 mg |
| Typical Component | 78 Weeks |
| Weight | 1 |
| Shelf Life |  |
| MSL |  |


| Specifications | 0.01 uF |
| :--- | :--- |
| Capacitance | 1 kHz 1.0 Vrms |
| Measurement Condition | $5 \%$ |
| Capacitance Tolerance | 25 VDC |
| Voltage DC | 62.5 VDC |
| Dielectric Withstanding Voltage | $-55 /+125^{\circ} \mathrm{C}$ |
| Temperature Range | U 2 J |
| Temperature Coefficient | $-750+/-120 \mathrm{ppm} / \mathrm{C}, 1 \mathrm{kHz}$ |
| Capacitance Change with Reference | 1.0 Vrms |
| to +25 ${ }^{\circ} \mathrm{C}$ and O VDC Applied (TCC) | $0.1 \% 1 \mathrm{kHz} 1.0 \mathrm{Vrms}$ |
| Dissipation Factor | $0.1 \%$ Loss/Decade Hour: |
| Aging Rate | Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |

